# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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## **SPECIFICATION**

(Reference sheet)

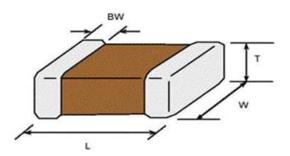
- · Supplier : Samsung electro-mechanics
- · Product : Multi-layer Ceramic Capacitor

- Samsung P/N : CL10C151
  Description : CAP, 150p
- CL10C151JB8NNNC CAP, 150pF, 50V, ± 5%, C0G, 0603

A. Samsung Part Number

		<u>C</u>		<u>C</u> 3	<u>151</u> ④	<mark>_</mark> 5	<u>B</u> 6	<mark>8</mark> 7	<u>N</u> 8	<u>N</u> 9	<u>N</u> 10	<mark>C</mark> 10
1	Series	Samsung Multi-layer Ceramic Capacitor										
2	Size	0603 (incl	n code)	L: 1.60 ± 0.10 mm W			W:	0.80 ± 0.10 mm				
3	Dielectric	C0G				8	Inner	elect	rode	•		Ni
4	Capacitance	<b>150</b> pF					Term	inatic	n			Cu
5	Capacitance	±5%					Platir	ng				Sn 100% (Pb Free)
	tolerance					9	Produ	uct				Normal
6	Rated Voltage	50 V				10	Spec	ial				Reserved for future use
$\bigcirc$	Thickness	0.80 ± 0.10 mm	า			1	Packa	aging				Cardboard Type, 7" reel

#### B. Structure and dimension



Samsung P/N	Dimension(mm)								
(Lead Free)	L	W	Т	BW					
CL10C151JB8NNNC	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.20					

#### C. Samsung Reliability Test and Judgement condition

QInsulation1ResistanceNAppearanceNWithstandingNVoltagenTemperatureCCharacteristics(	Vithin specified tolerance 1000 min 10,000Mohm or 500Mohm×µF Whichever is smaller No abnormal exterior appearance No dielectric breakdown or	1M±±10%         0.5~5Vrms           Rated Voltage         60~120 sec.           Microscope (´10)         0.500000000000000000000000000000000000				
Insulation1Resistance1Appearance1Withstanding1Voltage1TemperatureCCharacteristics(I	I0,000Mohm or 500Mohm× <i>µ</i> F Whichever is smaller No abnormal exterior appearance No dielectric breakdown or	Microscope (´10)				
ResistanceNAppearanceNWithstandingNVoltagenTemperatureCCharacteristics(I	Whichever is smaller No abnormal exterior appearance No dielectric breakdown or	Microscope (´10)				
AppearanceNWithstandingNVoltagenTemperatureCCharacteristics(I	No abnormal exterior appearance No dielectric breakdown or					
WithstandingNVoltagenTemperatureCCharacteristics(I	No dielectric breakdown or					
VoltagenTemperatureCCharacteristics(I						
TemperatureCCharacteristics(I	nachanical brackdown	300% of the rated voltage				
Characteristics (I	nechanical breakdown					
	COG					
Adhesive Strength	From -55℃ to 125℃, Capacitance change sh	nould be within ±30PPM/ິC)				
	No peeling shall be occur on the	500g×F, for 10±1 sec.				
of Termination te	erminal electrode					
Bending Strength C	Capacitance change :	Bending to the limit (1mm)				
w	vithin $\pm 5\%$ or $\pm 0.5  { m pF}$ whichever is larger	with 1.0mm/sec.				
Solderability N	Nore than 75% of terminal surface	SnAg3.0Cu0.5 solder				
is	s to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120 ℃ for 10~30sec.)				
Resistance to	Capacitance change :	Solder pot : 270±5℃, 10±1sec.				
Soldering heat	vithin ±2.5% or ±0.25pF whichever is larger					
-	Γan δ, IR : initial spec.					
Vibration Test	Capacitance change :	Amplitude : 1.5mm				
w	vithin $\pm 2.5\%$ or $\pm 0.25$ pF whichever is larger	From 10Hz to 55Hz (return : 1min.)				
	Γan δ, IR : initial spec.	2hours ´ 3 direction (x, y, z)				
Moisture C	Capacitance change :	With rated voltage				
Resistance w	vithin ±7.5% or ±0.75pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs				
G	Q: 200 min					
IF	R: 500Mohm or 25Mohm × $\mu$ F					
	Whichever is smaller					
High Temperature C	Capacitance change :	With 200% of the rated voltage				
Resistance w	vithin $\pm 3\%$ or $\pm 0.3  \text{pF}$ whichever is larger	Max. operating temperature				
C	Q: 350 min	1000+48/-0hrs				
IF	R : 1,000Mohm or 50Mohm × μF					
	Whichever is smaller					
Temperature C	Capacitance change :	1 cycle condition				
-	vithin ±2.5% or ±0.25pF whichever is larger	Min. operating temperature $\rightarrow$ 25 °C				
	Γan δ, IR : initial spec.	$\rightarrow$ Max. operating temperature $\rightarrow$ 25 °C				
		5 cycle test				

\* The reliability test condition can be replaced by the corresponding accelerated test condition.

#### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5°C, 10sec. Max )

A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

### - Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury. We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- *④ Military equipment*
- *5* Disaster prevention/crime prevention equipment
- *(6)* Any other applications with the same as or similar complexity or reliability to the applications set forth above.